# 2.5V Drive Nch MOS FET **RJK005N03**

#### Structure

Silicon N-channel MOS FET

#### Features

- 1) Low On-resistance.
- 2) Low voltage drive (2.5V drive).

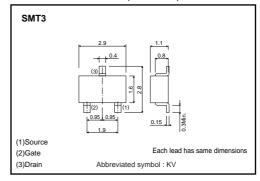
#### Applications

Switching

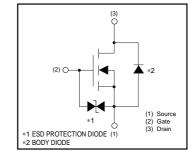
#### Packaging specifications and hre

	Package	Taping		
Туре	Code	T146		
	Basic ordering unit (pieces)	3000		
RJK005N03	0			

#### •External dimensions (Unit : mm)



#### Inner circuit



#### ●Absolute maximum ratings (Ta=25°C)

Parameter		Symbol	Limits	Unit
Drain-source voltage		Vdss	30	V
Gate-source voltage		Vgss	±12	V
Durin autorat	Continuous	lD	±500	mA
Drain current	Pulsed	DP *1	±2.0	Α
Source current	Continuous	ls	200	mA
(Body Diode)	Pulsed	Isp *1	800	mA
Total power dissipation		Po *2	200	mW
Channel temperature		Tch	150	°C
Range of storage temperature		Tstg	-55 to +150	°C

\*1 Pw≤10µs, Duty cycle≤1%
\*2 Each terminal mounted on a recommended land

#### Thermal resistance

Channel to ambient Rth(ch-	-a)* 625	°C/W

\* Each terminal mounted on a recommended land



# Transistors

## •Electrical characteristics (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Gate-source leakage	lgss	-	-	±10	μA	Vgs=±12V, Vds=0V
Drain-source breakdown voltage	V(BR) DSS	30	-	-	V	I <sub>D</sub> = 1mA, V <sub>GS</sub> =0V
Zero gate voltage drain current	IDSS	-	-	1	μΑ	V <sub>DS</sub> = 30V, V <sub>GS</sub> =0V
Gate threshold voltage	V <sub>GS (th)</sub>	0.8	_	1.5	V	V <sub>DS</sub> = 10V, I <sub>D</sub> = 1mA
Static drain-source on-state resistance	R <sub>DS</sub> (on)*	-	400	580	mΩ	I <sub>D</sub> = 500mA, V <sub>GS</sub> = 4.5V
		-	420	600	mΩ	I <sub>D</sub> = 500mA, V <sub>GS</sub> = 4V
		-	650	940	mΩ	I <sub>D</sub> = 500mA, V <sub>GS</sub> = 2.5V
Forward transfer admittance	Y <sub>fs</sub> *	0.5	_	_	S	V <sub>DS</sub> = 10V, I <sub>D</sub> = 500mA
Input capacitance	Ciss	-	60	-	pF	V <sub>DS</sub> = 10V
Output capacitance	Coss	-	24	-	pF	V <sub>GS</sub> =0V
Reverse transfer capacitance	Crss	-	12	_	pF	f=1MHz
Turn-on delay time	t <sub>d (on)</sub> *	-	9	_	ns	Vdd≒ 15V
Rise time	tr *	-	11	_	ns	$I_{D}=250mA$
Turn-off delay time	t <sub>d (off)</sub> *	-	16	_	ns	Vgs= 4V R∟=60Ω
Fall time	t <sub>f</sub> *	-	31	-	ns	$R_{G}=10\Omega$
Total gate charge	Qg *	-	2.0	4.0	nC	V <sub>DD</sub> ≒24V
Gate-source charge	Q <sub>gs</sub> *	-	0.6	-	nC	V <sub>GS</sub> =4V
Gate-drain charge	Q <sub>gd</sub> *	_	0.7	_	nC	I <sub>D</sub> = 500mA

# •Body diode characteristics (Source-drain) (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Forward voltage	Vsd*	-	-	1.2	V	Is= 500mA, V <sub>GS</sub> =0V
*Pulsed						



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